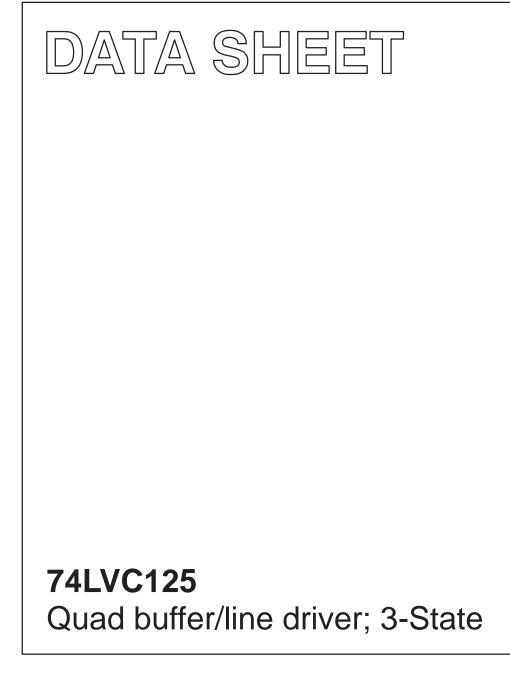
INTEGRATED CIRCUITS



Product specification Supersedes data of February 1996 IC24 Data Handbook 1997 Mar 18





74LVC125

FEATURES

- Wide supply voltage range of 1.2 to 3.6 V
- In accordance with JEDEC standard no. 8-1A
- Inputs accept voltages up to 5.5 V
- CMOS lower power consumption
- Direct interface with TTL levels
- Output drive capability 50 Ω transmission lines at 85°C

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

DESCRIPTION

The 74LVC125 is a high performance, low-power, low-voltage Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

The 74LVC125 consists of four non-inverting buffers/line drivers with 3-State outputs. The 3-State outputs (nY) are controlled by the output enable input (nOE). A HIGH at nOE causes the outputs to assume a high impedance OFF-state.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay nA to nY	$\begin{array}{l} C_L = 15 \text{ pF}; \\ V_{CC} = 3.3 \text{ V} \end{array}$	3.5	ns
Cl	Input capacitance		5.0	pF
C _{PD}	Power dissipation capacitance per buffer	Notes 1 and 2	22	pF

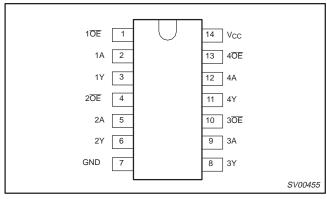
NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: $f_{i} = input frequency in MHz; C_{L} = output load capacity in pF; f_{o} = output frequency in MHz; V_{CC} = supply voltage in V;$ $<math display="block">\Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) = sum of the outputs.$ 2. The condition is V_I = GND to V_{CC}

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic SO	-40°C to +85°C	74LVC125 D	74LVC125 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +85°C	74LVC125 DB	74LVC125 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +85°C	74LVC125 PW	74LVC125PW DH	SOT402-1

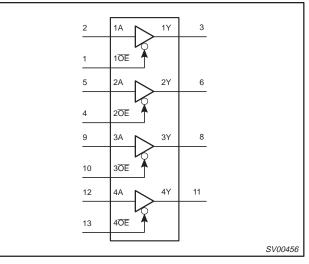
PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 4, 10, 13	$1\overline{OE} - 4\overline{OE}$	Data enable inputs (active LOW)
2, 5, 9, 12	1A – 4A	Data inputs
3, 6, 8, 11	1Y – 4Y	Data Outputs
7	GND	Ground (0 V)
14	V _{CC}	Positive supply voltage

LOGIC SYMBOL



74LVC125

FUNCTION TABLE

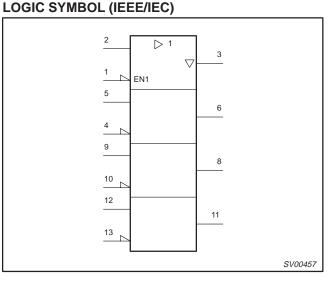
INP	OUTPUT	
nOE	nA	nY
L	L	L
L	н	Н
н	Х	Z

NOTES:

H = HIGH voltage level L = LOW voltage level

X = don't care

Z = high impedance OFF-state



RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIM	UNIT	
STMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V _{CC}	DC supply voltage (for max. speed performance)		2.7	3.6	V
V _{CC}	DC supply voltage (for low-voltage applications)		1.2	3.6	V
VI	DC input voltage range		0	5.5	V
V _{I/O}	DC input voltage range for I/Os		0	V _{CC}	V
Vo	DC output voltage range		0	V _{CC}	V
T _{amb}	Operating free-air temperature range		-40	+85	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.2 \text{ to } 2.7 \text{V}$ $V_{CC} = 2.7 \text{ to } 3.6 \text{V}$	0 0	20 10	ns/V

ABSOLUTE MAXIMUM RATINGS¹

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +6.5	V
I _{IK}	DC input diode current	V ₁ < 0	-50	mA
VI	DC input voltage	Note 2	-0.5 to +5.5	V
V _{I/O}	DC input voltage range for I/Os		–0.5 to V _{CC} +0.5	V
I _{OK}	DC output diode current	$V_{O} > V_{CC} \text{ or } V_{O} < 0$	± 50	mA
V _{OUT}	DC output voltage	Note 2	–0.5 to V _{CC} +0.5	V
I _{OUT}	DC output source or sink current	$V_{O} = 0$ to V_{CC}	± 50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		±100	mA
T _{stg}	Storage temperature range		-60 to +150	°C
P _{TOT}	Power dissipation per package – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

				L	UNIT			
SYMBOL	PARAMETER	TEST CONDITION	NS	Temp = -40°C to +85°C				
				MIN	TYP ¹	MAX		
M		V _{CC} = 1.2V		V _{CC}			v	
VIH	HIGH level Input voltage	V _{CC} = 2.7 to 3.6V		2.0] `	
M		V _{CC} = 1.2V				GND	v	
VIL	LOW level Input voltage	V _{CC} = 2.7 to 3.6V				0.8	1 `	
		V_{CC} = 2.7V; V_{I} = V_{IH} or V_{IL} ; I_{O} =	-12mA	V _{CC} -0.5				
V	HIGH level output voltage	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O =$	V _{CC} -0.2	V _{CC}				
V _{ОН}		V_{CC} = 3.0V; V_{I} = V_{IH} or V_{IL} ; I_{O} =	V _{CC} -0.6					
		V_{CC} = 3.0V; V_{I} = V_{IH} or V_{IL} ; I_{O} =	V _{CC} -1.0					
		V_{CC} = 2.7V; V_{I} = V_{IH} or V_{IL} ; I_{O} =	: 12mA			0.40		
V _{OL}	LOW level output voltage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$			GND	0.20	V	
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 24mA$				0.55	1	
tı	Input leakage current	V_{CC} = 3.6V; V_{I} = 5.5V or GND	Not for I/O pins		±0.1	±5	μΑ	
I _{IHZ} /I _{ILZ}	Input current for common I/O pins	V_{CC} = 3.6V; V_{I} = V_{CC} or GND			±0.1	±15	μΑ	
I _{OZ}	3-State output OFF-state current	$V_{CC} = 3.6V; V_I = V_{IH} \text{ or } V_{IL}; V_O = V_{CC} \text{ or } GND$			0.1	±10	μΑ	
I _{CC}	Quiescent supply current	$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND; $I_O = 0$			0.1	20	μΑ	
ΔI_{CC}	Additional quiescent supply current per input pin	V_{CC} = 2.7V to 3.6V; V_{I} = V_{CC} –0	0.6V; I _O = 0		5	500	μA	

NOTE:

1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

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AC CHARACTERISTICS

GND = 0 V; $t_r = t_f = 2.5 \text{ ns}$; $C_L = 50 \text{ pF}$; $R_L = 500\Omega$; $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$.

						LIMI	rs			
SYMBOL	PARAMETER	WAVEFORM	V _{CC} = 3.3V ±0.3V		v	/ _{CC} = 2.7\	/	V _{CC} = 1.2V	UNIT	
			MIN	TYP ¹	MAX	MIN	TYP	MAX	TYP	
t _{PHL} t _{PLH}	Propagation delay nA to nY	Figure 1, 3		3.5	6.5		3.9	7.0		ns
t _{PZH} t _{PZL}	3-state output enable time nOE to nY	Figure 2, 3		3.8	7.0		4.4	8.0		ns
t _{PHZ} t _{PLZ}	3-state output disable time nOE to nY	Figure 2, 3		3.3	5.5		4.0	6.5		ns

NOTE:

1. These typical values are at V_{CC} = 3.3V and T_{amb} = 25° C.

AC WAVEFORMS

 V_M = 1.5 V at V_{CC} \geq 2.7 V V_M = 0.5 × V_{CC} at V_{CC} < 2.7 V V_{OL} and V_{OH} are the typical output voltage drop that occur with the

output load.

 $\begin{array}{l} \mathsf{V_X} = \mathsf{V_{OL}} + 0.3 \; \forall \; at \; \mathsf{V_{CC}} \geq 2.7 \; \mathsf{V}; \\ \mathsf{V_X} = \mathsf{V_{OL}} + 0.1 \times \mathsf{V_{CC}} \; at \; \mathsf{V_{CC}} < 2.7 \; \mathsf{V}; \\ \mathsf{V_Y} = \mathsf{V_{OH}} - 0.3 \; \forall \; at \; \mathsf{V_{CC}} \geq 2.7 \; \mathsf{V}; \\ \mathsf{V_Y} = \mathsf{V_{OH}} - 0.1 \times \mathsf{V_{CC}} \; at \; \mathsf{V_{CC}} < 2.7 \; \mathsf{V}. \end{array}$

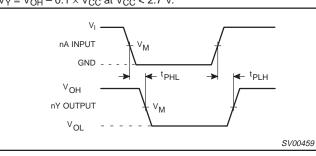


Figure 1. Input (nA) to output (nY) propagation delays.

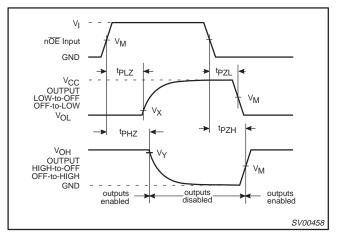


Figure 2. 3-State enable and disable times.

TEST CIRCUIT

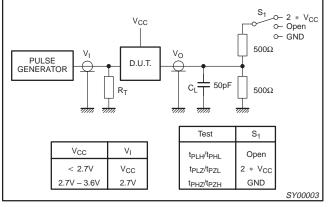
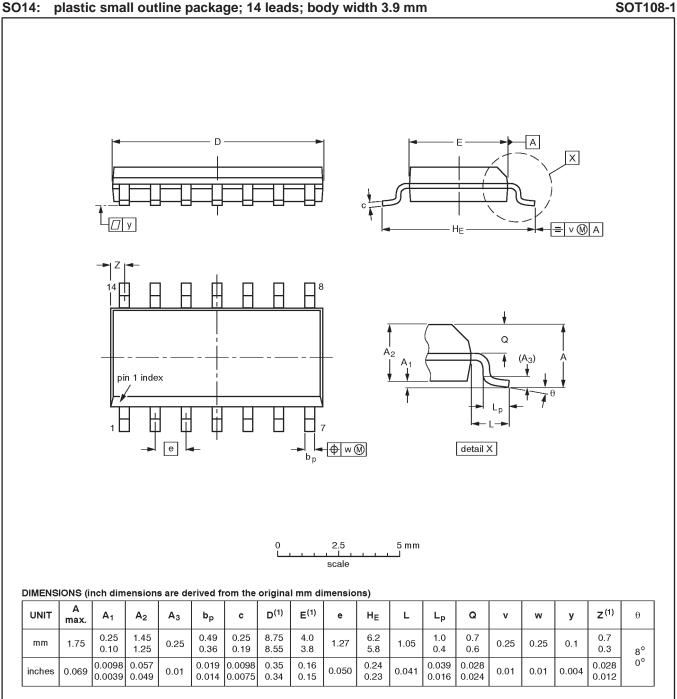


Figure 3. Load circuitry for switching times.

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74LVC125

Product specification

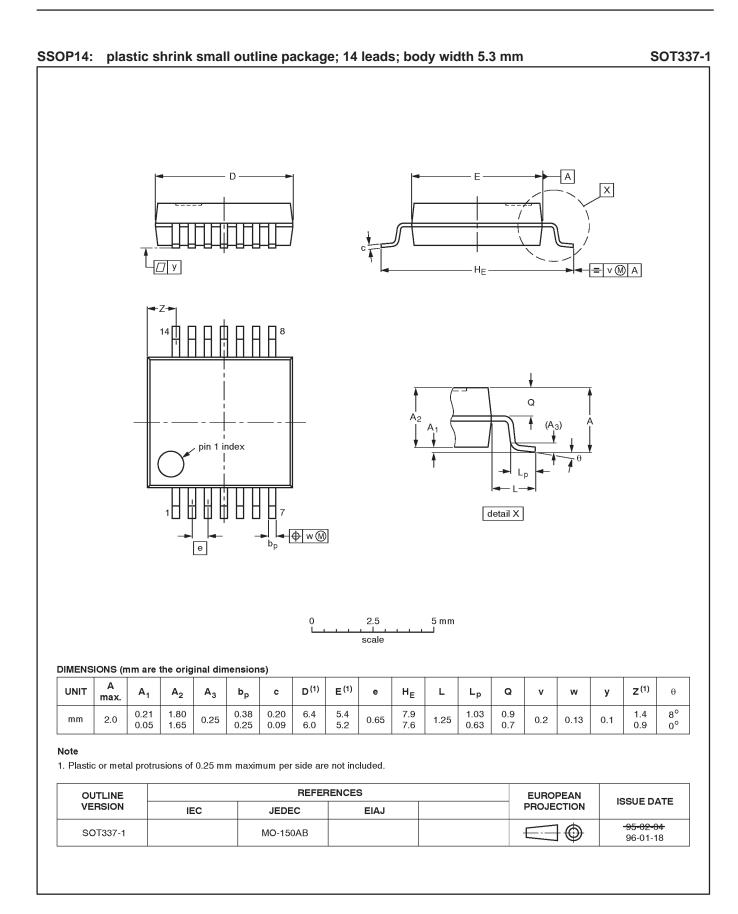


Note

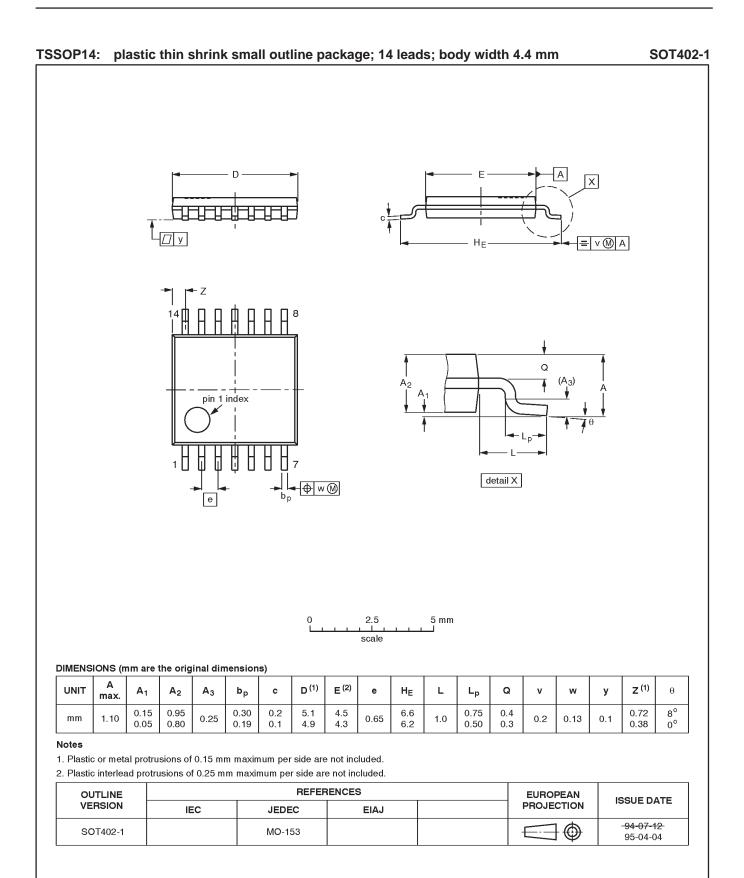
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE	E REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT108-1	076E06S	MS-012AB				91-08-13- 95-01-23

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NOTES

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	DEFINITIONS				
Data Sheet Identification Product Status Definition		Definition			
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